	r documentation	N PAGE UIC	FILE COP	Aceroves 40. 0704-0188
AGENCY USE ONLY (Look	GIENE 12. REPORT DATE	J. AEPORT T	PE AND DATES COVER	TO ONE OF JOHN STATE OF THE STATE OF JOHN ST
DOD-URIP Thin F	ilm Deposition Equip	oment - Phase II	S. FUNDING NO	84-0370
K.M. Lakin H.S. Shanks				
Iowa State University Ames, Iowa 5001	-		E. PERFORMING ALPORT NUM	
SPONSORMS / MONITORIN	G AGENCY NAMELS) AND ADDR	ussis)	10. SPONSORING AGENCY RES	S/MONITORING PORT NUMBER
US Air Force.				
Approved for distribution	r nublic release; on unlimited.		12b. OSTRBUTI	ON CODE
and installed as was added with I	ionized cluster bear s part of a thin film ISO matching funds. Coura State Trace TE	m deposition sysm research facility (Cywords), acted.	ity. A scanning	sed ing auger sys in the lag in the lag
SUBJECT TERMS				MARIA OF PAGES

Final Report

DoD-URIP Thin Film Deposition Equipment - Phase II

AFOSR-84-0370



bу

K.M. Lakin

H.S. Shanks

Repo Date 1984 per D. Tyrell AFOS. AOTD, Bldg. 410, Bolling AFB, DC 20332-6448 TELECON 7/26/90 VC

cistuiphtion musicalisasis

Accessors For	
NTIS CRA&I DTIC TAB Unannounced Justification	0
By per call Distribution /	2
Availability	Codes
Dist Avail	

AIR FERCE OFFICE OF SCIENTIFIC RESEARCH (AFSC)
TO TOE OF TRANSMITTED TO DTIC

Mis technical report has been reviewed and in
antivoved for public release IAW AFR 190-12.
Distribution is unlimited.
TIMEW J. KERPER
Chief, Technical Information Division

The 1984 DoD University Research Instrumentation Program Grant to ISU was for Phase II of construction of a major thin film research facility. The grant was to provide for a three source ultrahigh vacuum (UHV) ionized cluster beam (ICB) deposition system to be connected to the UHV transfer system constructed in Phase I. Cost sharing on the grant by ISU provided for a scanning Auger system.

The overall plan for the facility is shown in Figure 1. The sputtering system was constructed previously as part of a research program on deposition of AlN thin films supported by AFOSR. It is currently being used to deposit high purity oriented AlN films on silicon substrates. The electron energy loss spectrometer (EELS) with LEED and UPS was constructed with partial support from DoE and ISU funds. The EELS is being used to study surface phonons on single crystal and amorphous silicon. These measurements are supported by theoretical first-principle calculations of silicon surface phonons by a local theorist Dr. Kai-Ming Ho.

The single source ICB is being used for epitaxial film studies. A number of oriented films of aluminum have been grown on silicon substrates. The films show no oxygen or carbon impurities but have some interaction with the silicon at the interface. Films of epitaxial (100) germanium are now being grown on (100) silicon at 400°C with sharp interfaces. No carbon crucible contamination is found.

The three source ICB system constructed with this grant has a locally designed vacuum chamber with a base pressure of $< 5 \times 10^{-10}$ Torr. In addition to three ports for ICB sources, the base plate also has ports for conventional style MBE effusion cells to increase the flexibility of the system for compound deposition. The chamber has ports for RHEED and ellipsometry. Three second generation sources and power supplies were purchased from Eaton Corporation. As modified for our systems, these sources have been repeatedly heated to ~1700°C with little difficulty. This is in contrast to the initial source for the single source system which had to be rebuilt after each run.

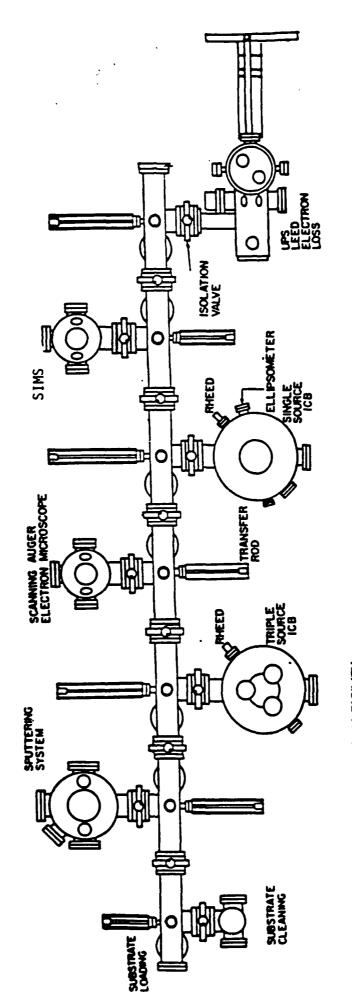
The three sources, with all support leads, are built on individual 8 inch OD flanges for rapid removal for servicing. Each also has a port for crucible introduction. These sources are water cooled to reduce heating of the chamber and undesirable outgasing.

The three power supplies were damaged in shipment and have required extensive repair before use. The three supplies and associated controls are totally independent so that each can be operated separately or from a single control.

A scanning Auger based on the Perkin Elmer 545 system has been constructed. It incorporates a Kratos rastorable ion gun for depth profiling. Lateral resolution for imaging and Auger mapping is about 1 μ m. A depth profile of an AlN film is shown in Figure 2.

The Auger chamber makes use of differential pumping of the ion gun and a load-lock to maintain a low pressure at all times in the analysis chamber. A base pressure of $< 2 \times 10^{-10}$ Torr. is routine.

As the lowest possible base pressures are required in all the systems, efforts have been concentrated on getting each system operational with its own load-lock. This allows independent operation during initial test periods when the vacuum systems must be repeatedly cycled to atmospheric pressure. Each system is integrated with the transfer line once it is fully operational.



I.S.U. THIN FILM FACILITY

This grant provided for the purchase ISU Thin Film Facility. This grant provided for the purchase of the three source ICB system and the scanning Auger system. Figure 1.

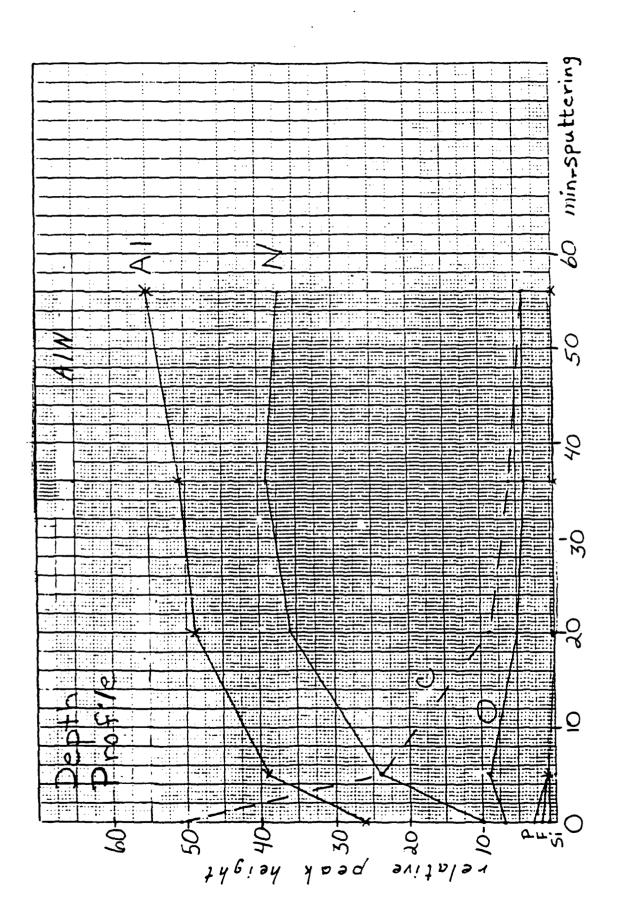


Figure 2. Auger depth profile of AlN sample.